



| Parameter | Rating | Units |
|---------------------|--------|----------------------|
| Blocking Voltage | 400 | V_P |
| Load Current | 150 | mA_{rms} / mA_{DC} |
| On-Resistance (max) | 22 | Ω |

Features

- 3750V_{rms} Input/Output Isolation
- Low Drive Power Requirements (TTL/CMOS Compatible)
- FCC Compatible
- VDE Compatible
- No EMI/RFI Generation
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- Small 8-Pin Package
- Machine Insertable, Wave Solderable
- Surface Mount and Tape & Reel Versions Available

Applications

- Telecommunications
 - Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, Pocket Size)
 - Hook Switch
 - Dial Pulsing
 - Ground Start
 - Ringing Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

The TS190 integrated circuit device combines a 400V, normally open (1-Form-A) relay with an optocoupler in a single package. The relay, with enhanced peak load current handling capability, uses optically coupled MOSFET technology to provide 3750V_{rms} of input to output isolation.

Its optically coupled outputs, which use the patented OptoMOS architecture, are controlled by a highly efficient GaAIAs infrared LED.

Telecom circuit designers, using the TS190, can now take advantage of two discrete functions in a single component that uses less space than traditional discrete component solutions.

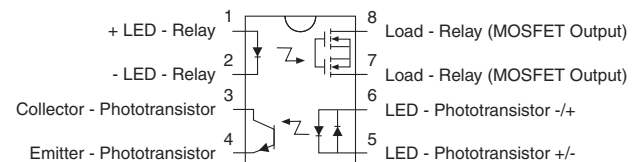
Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950 Certified Component:
TUV Certificate: B 10 05 49410 006

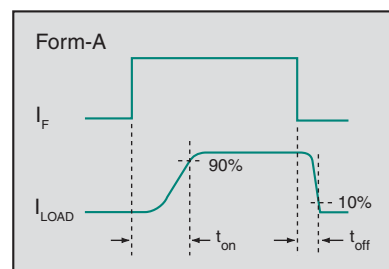
Ordering Information

| Part # | Description |
|----------|---------------------------------|
| TS190 | 8-Pin DIP (50/Tube) |
| TS190P | 8-Pin Flatpack (50/Tube) |
| TS190PTR | 8-Pin Flatpack (1000/Reel) |
| TS190S | 8-Pin Surface Mount (50/Tube) |
| TS190STR | 8-Pin Surface Mount (1000/Reel) |

Pin Configuration



Switching Characteristics of Normally Open Devices



Absolute Maximum Ratings @ 25°C

| Parameter | Ratings | Units |
|--|-------------|------------------|
| Relay Blocking Voltage | 400 | V _P |
| Input Power Dissipation ¹ | 150 | mW |
| Input Control Current, Relay Peak (10ms) | 50 | mA |
| | 1 | A |
| Reverse Input Voltage | 5 | V |
| Input Control Current, Detector | 100 | mA |
| Total Power Dissipation ² | 800 | mW |
| Isolation Voltage, Input to Output | 3750 | V _{rms} |
| Operational Temperature | -40 to +85 | °C |
| Storage Temperature | -40 to +125 | °C |

¹ Derate linearly 1.33 mW / °C

² Derate linearly 6.67 mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

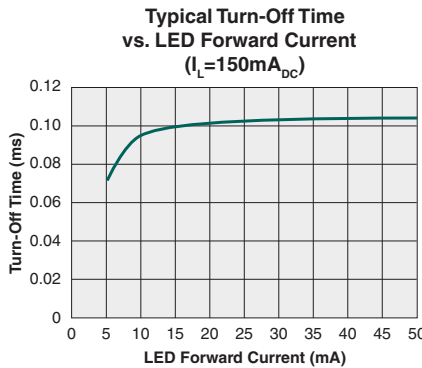
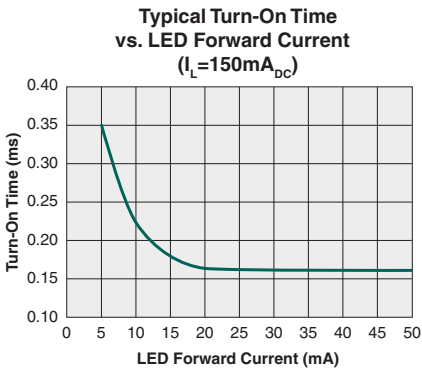
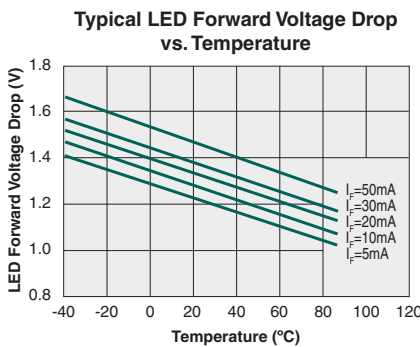
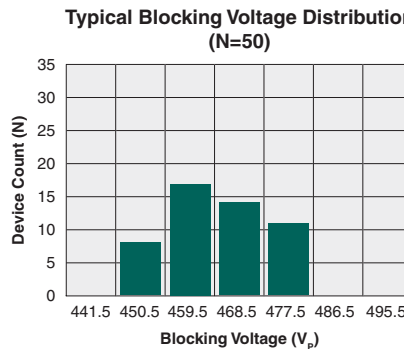
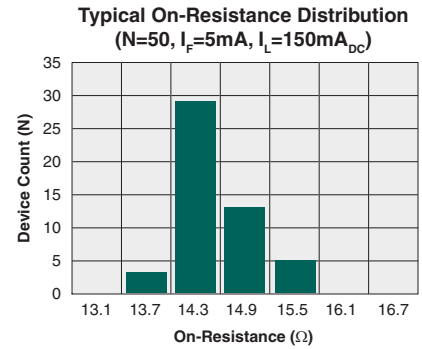
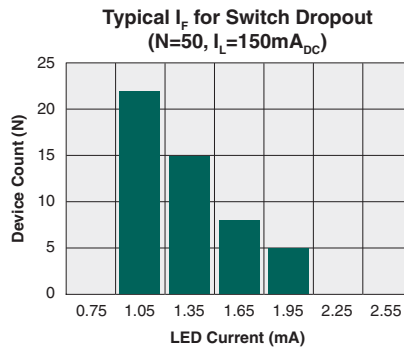
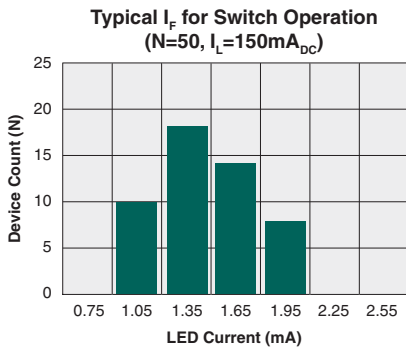
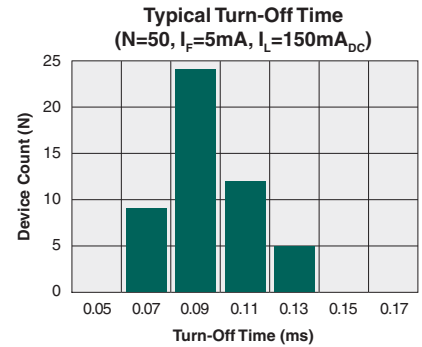
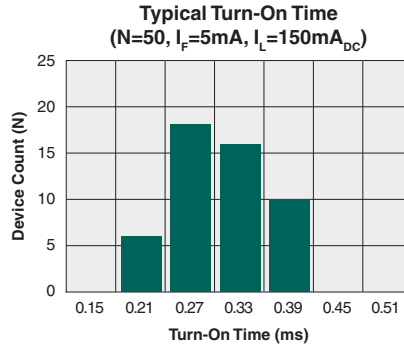
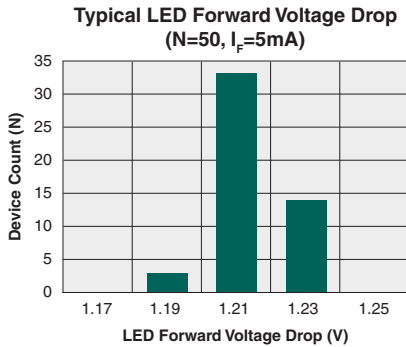
Electrical Characteristics @25°C: Relay Section

| Parameter | Conditions | Symbol | Min | Typ | Max | Units |
|-------------------------------------|--|-------------------|-----|-----|------|--------------------------------------|
| Output Characteristics | | | | | | |
| Load Current | - | I _L | - | - | 150 | mA _{rms} / mA _{DC} |
| | | | | | | |
| Peak | t=10ms | I _{LPK} | - | - | ±400 | mA _P |
| On-Resistance | I _L =150mA | R _{ON} | - | 15 | 22 | Ω |
| Off-State Leakage Current | V _L =400V | I _{LEAK} | - | - | 1 | μA |
| Switching Speeds | | | | | | |
| Turn-On | I _F =5mA, V _L =10V | t _{on} | - | - | 1 | ms |
| Turn-Off | | t _{off} | - | - | 0.25 | |
| Output Capacitance | V _L =50V, f=1MHz | C _{OUT} | - | 25 | - | pF |
| Input Characteristics | | | | | | |
| Input Control Current to Activate | I _L =120mA | I _F | - | - | 5 | mA |
| Input Dropout Current to Deactivate | - | I _F | 0.4 | 0.7 | - | mA |
| Input Voltage Drop | I _F =5mA | V _F | 0.9 | 1.2 | 1.4 | V |
| Reverse Input Current | V _R =5V | I _R | - | - | 10 | μA |
| Common Characteristics | | | | | | |
| Input to Output Capacitance | - | C _{I/O} | - | 3 | - | pF |

Electrical Characteristics @25°C: Detector Section

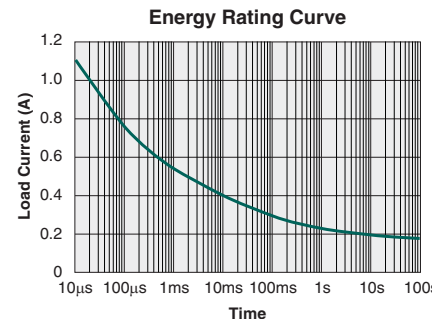
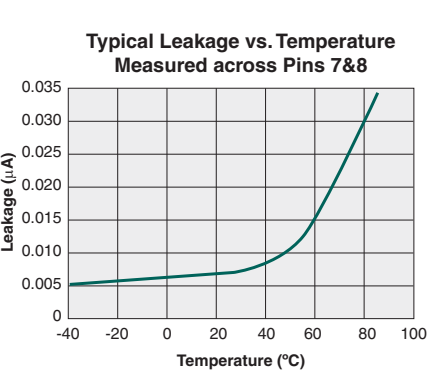
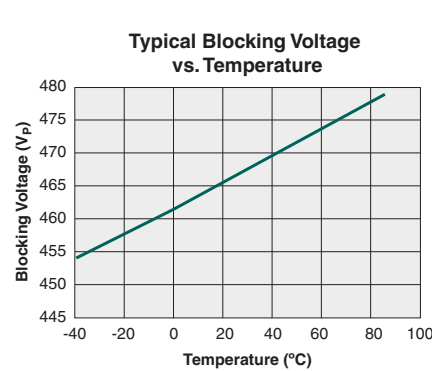
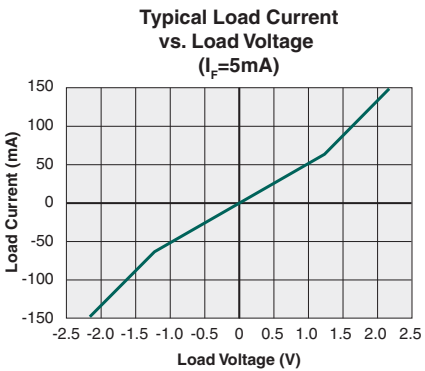
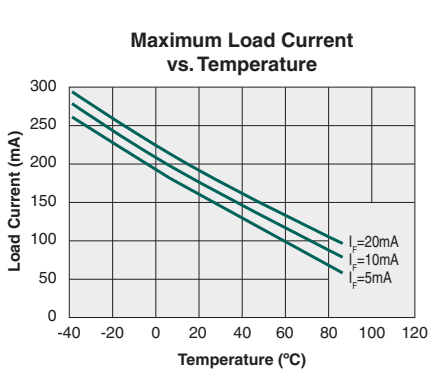
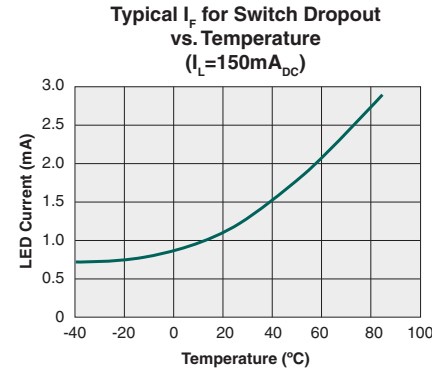
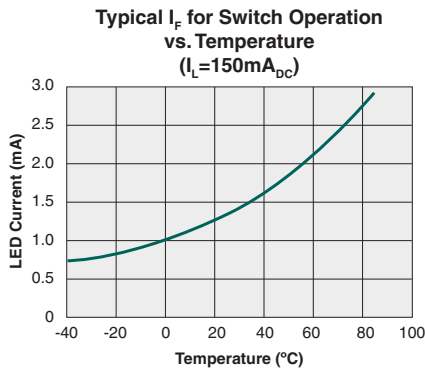
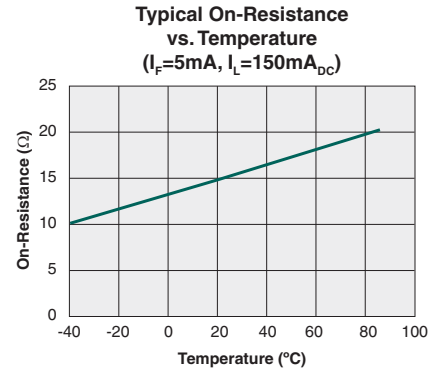
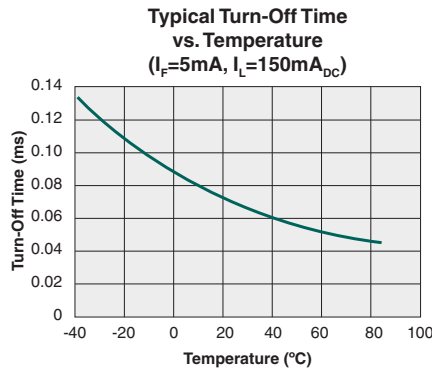
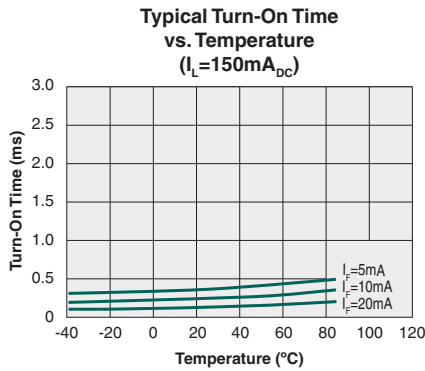
| Parameter | Conditions | Symbol | Min | Typ | Max | Units |
|--------------------------------------|--|-------------------|------|-----|-----|------------------|
| Output Characteristics | | | | | | |
| Phototransistor Blocking Voltage | I _C =10μA | BV _{CEO} | 20 | 50 | - | V |
| Phototransistor Dark Current | V _{CE} =5V, I _F =0mA | I _{CEO} | - | 50 | 500 | nA |
| Saturation Voltage | I _C =2mA, I _F =16mA | V _{SAT} | - | 0.3 | 0.5 | V |
| Current Transfer Ratio | I _F =6mA, V _{CE} =0.5V | CTR | 33 | 100 | - | % |
| Input Characteristics | | | | | | |
| Input Control Current | I _C =2mA, V _{CE} =0.5V | I _F | - | 2 | 6 | mA |
| Input Voltage Drop | I _F =5mA | V _F | 0.9 | 1.2 | 1.4 | V |
| Input Current (Detector must be off) | I _C =1μA, V _{CE} =5V | I _F | 5 | 25 | - | μA |
| Isolation, Input to Output | - | V _{I/O} | 3750 | - | - | V _{rms} |

RELAY PERFORMANCE DATA @25°C (Unless Otherwise Noted)*



* The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

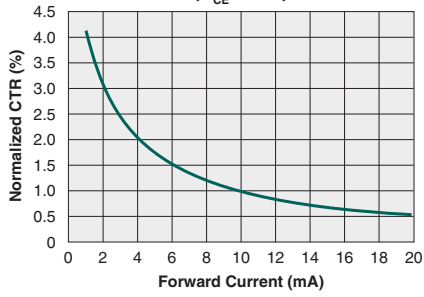
RELAY PERFORMANCE DATA @25°C (Unless Otherwise Noted)*



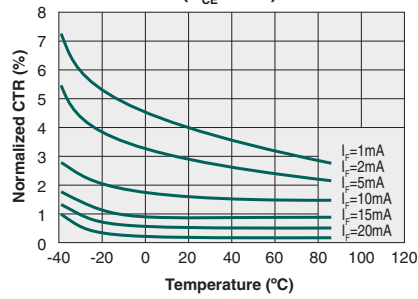
* The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

DETECTOR PERFORMANCE DATA @25°C (Unless Otherwise Noted)*

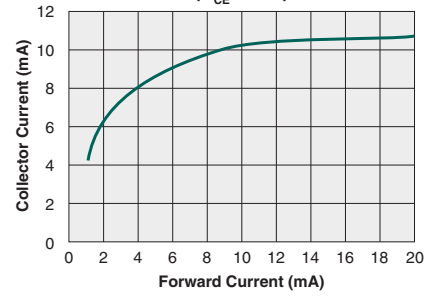
Typical Normalized CTR vs Forward Current
($V_{CE}=0.5V$)



Typical Normalized CTR vs. Temperature
($V_{CE}=0.5V$)



Typical Collector Current vs. Forward Current
($V_{CE}=0.5V$)



* The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

| Device | Moisture Sensitivity Level (MSL) Rating |
|-------------------------|---|
| TS190 / TS190P / TS190S | MSL 1 |

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

| Device | Maximum Temperature x Time |
|----------------|----------------------------|
| TS190 / TS190S | 250°C for 30 seconds |
| TS190P | 260°C for 30 seconds |

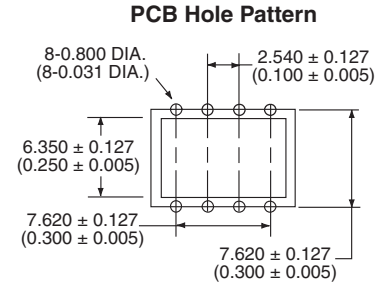
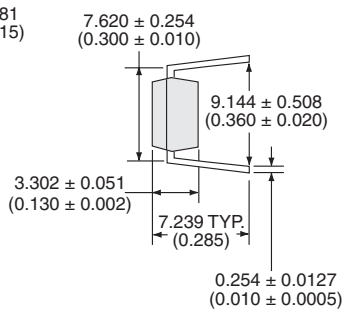
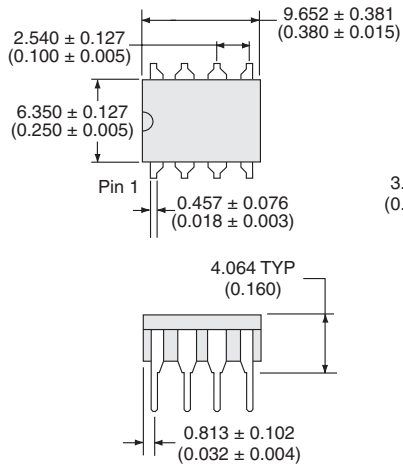
Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.



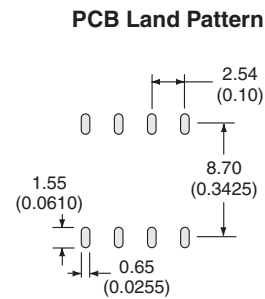
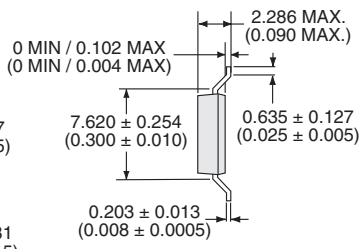
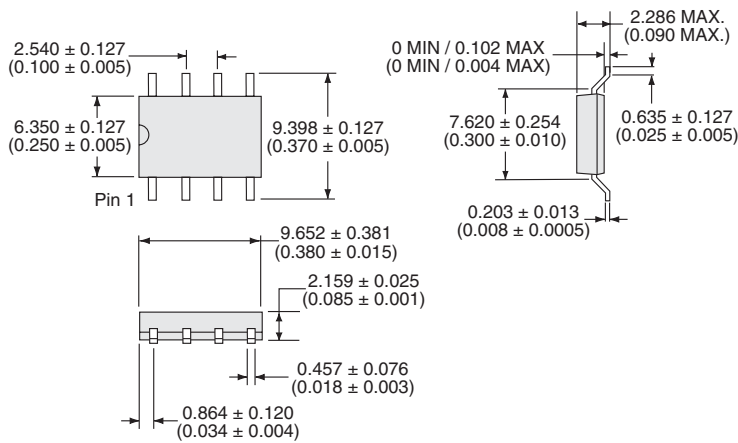
Mechanical Dimensions

TS190



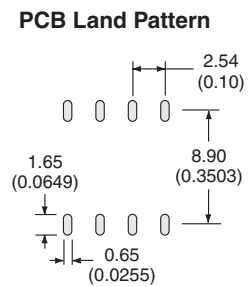
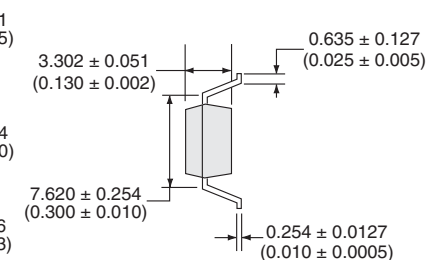
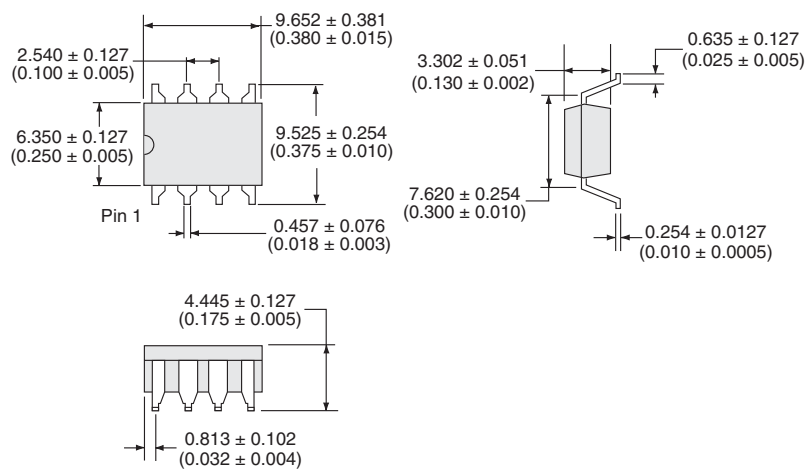
Dimensions
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(inches)

TS190P



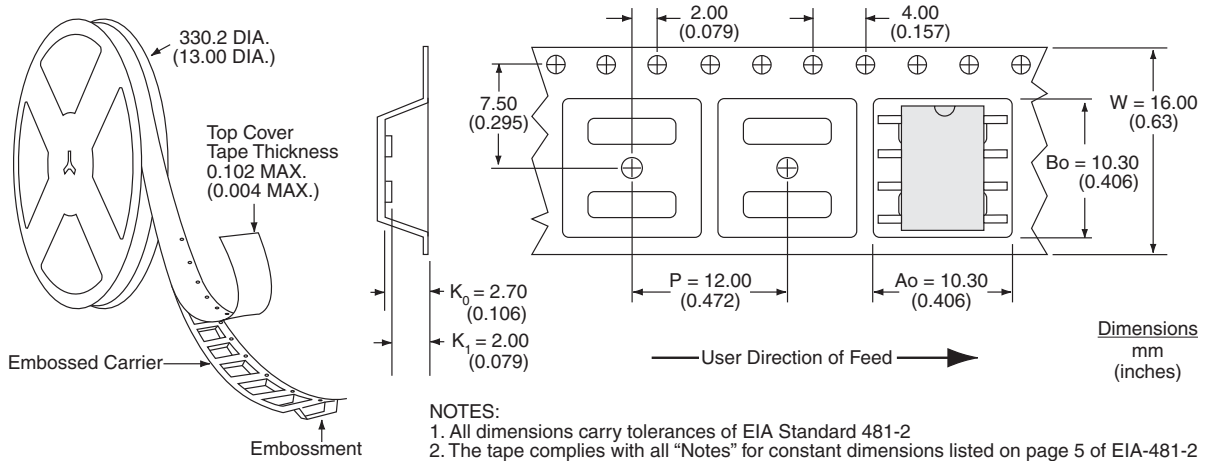
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TS190S

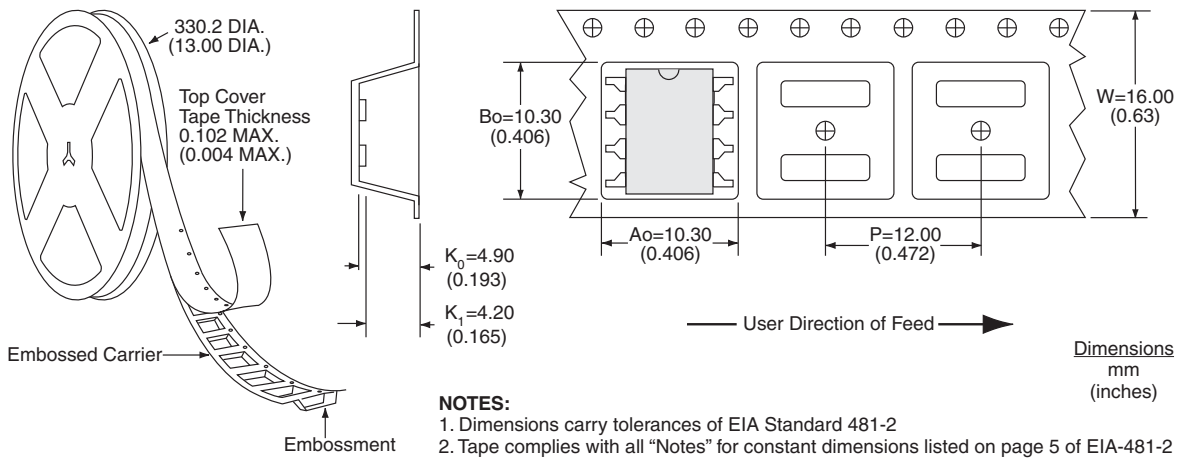


Dimensions
mm
(inches)

TS190PTR Tape & Reel



TS190STR Tape & Reel



For additional information please visit our website at: www.ixysic.com

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С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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